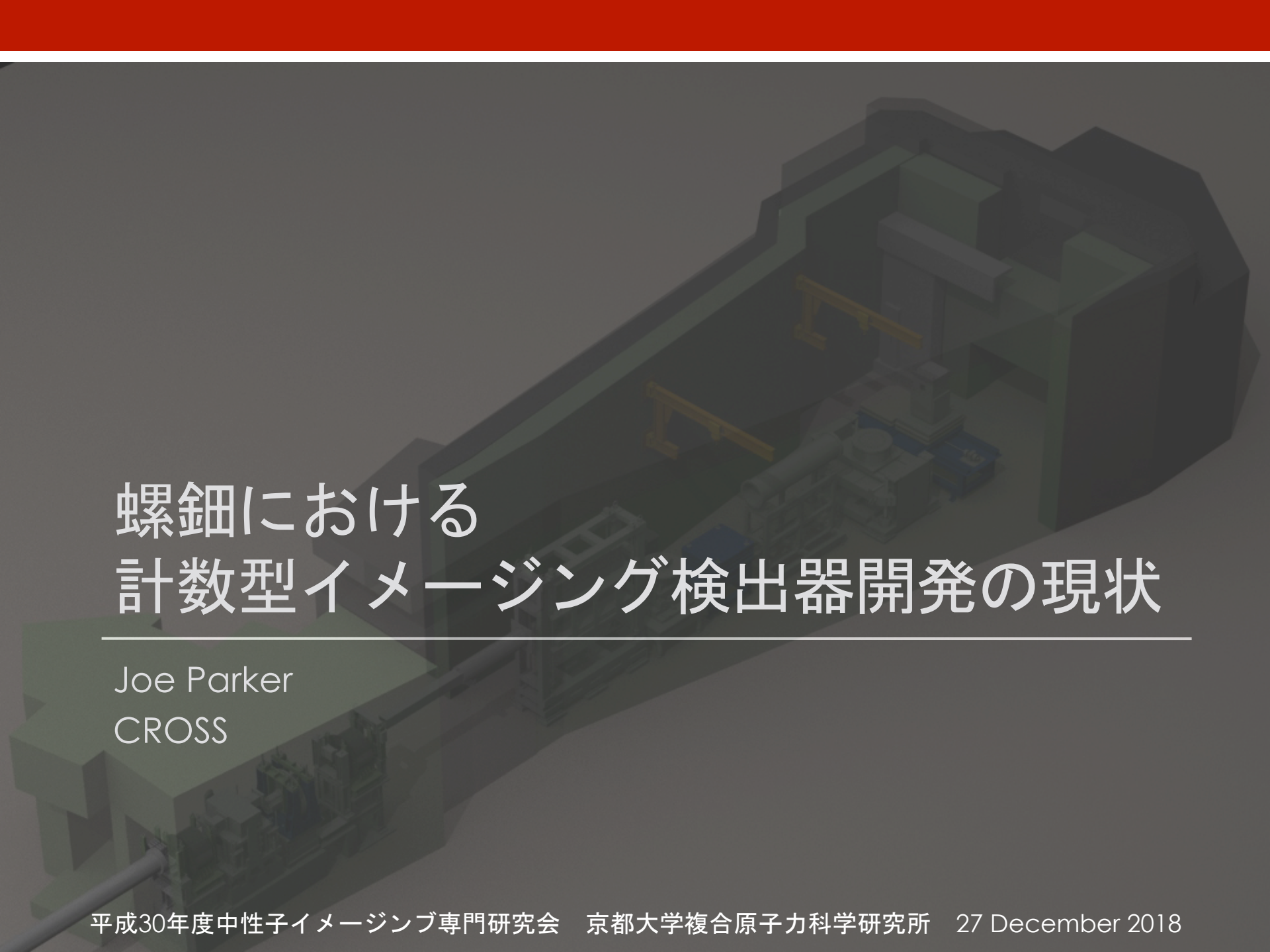


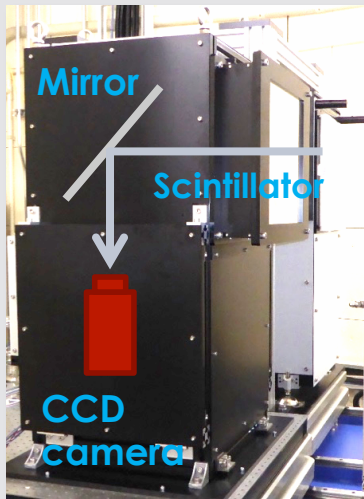
A 3D cutaway rendering of a tokamak reactor, showing the complex internal structure including the toroidal field coils, poloidal field coils, and the central column. The image is rendered in a dark, industrial style with some components highlighted in yellow and blue.

螺鈿における 計数型イメージング検出器開発の現状

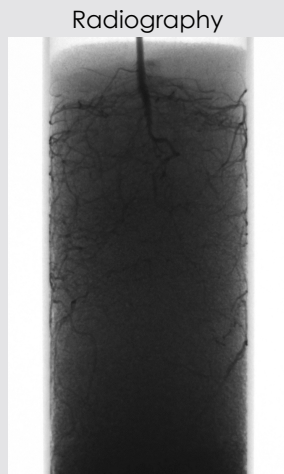
Joe Parker
CROSS

Neutron imaging at RADEN

Conventional



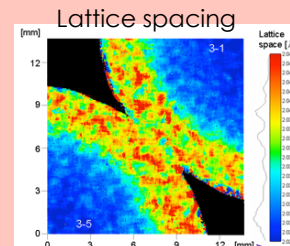
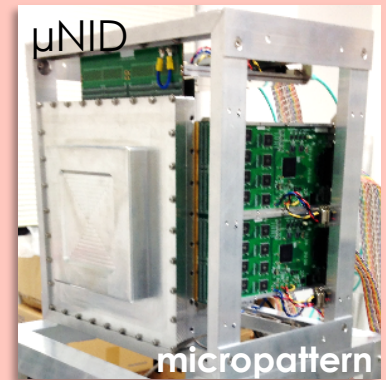
- CCD camera detectors: 50-300 μ m spatial resolution, no TOF
- Radiography and computed tomography



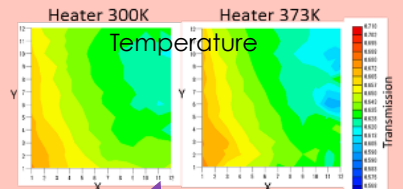
Sample: Roots of soybean plant (Nakazono, Nagoya U.)

Energy-resolved

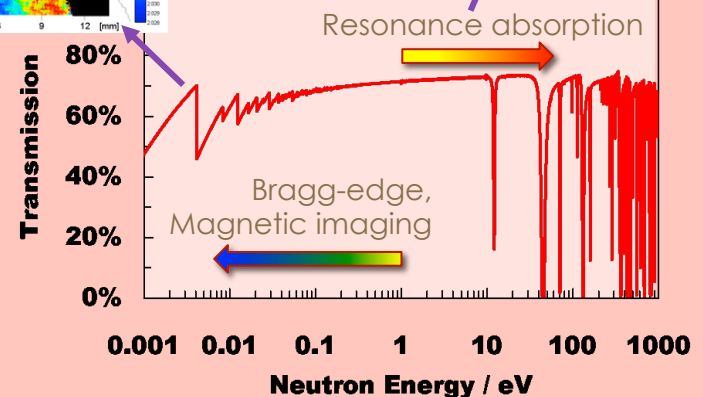
- Event-type detectors: sub-mm spatial and sub- μ s time resolutions, neutron energy via TOF
- Energy-dependent neutron transmission: macroscopic distribution of microscopic quantities



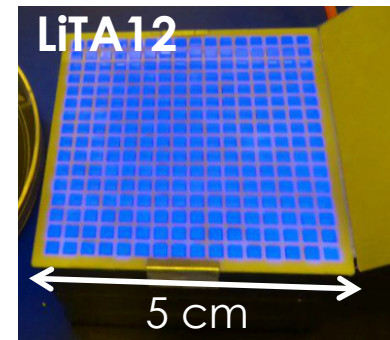
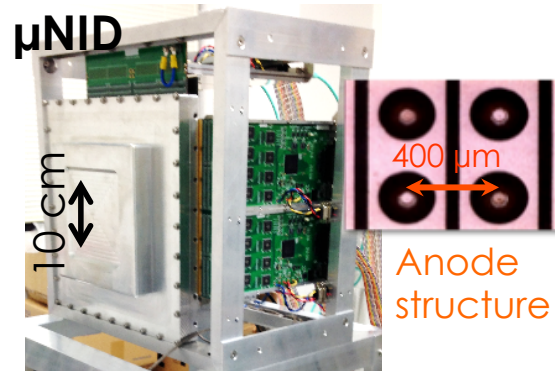
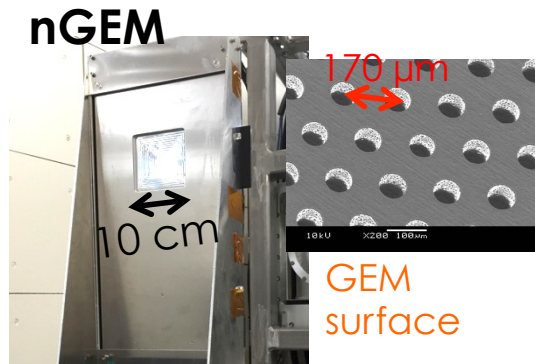
Sample: Iron rods



Sample: NdFeB magnet

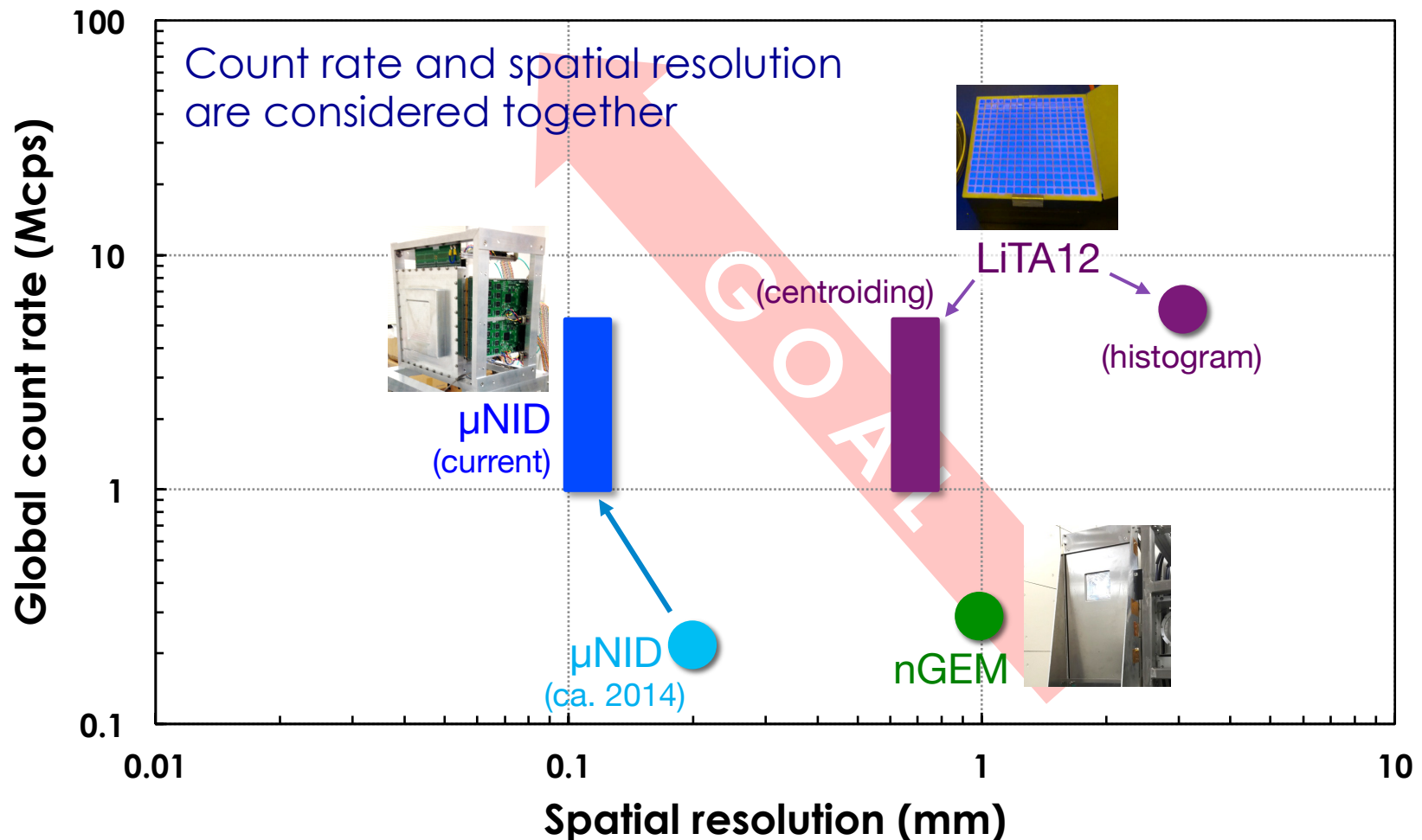


Event-type detectors at RADEN

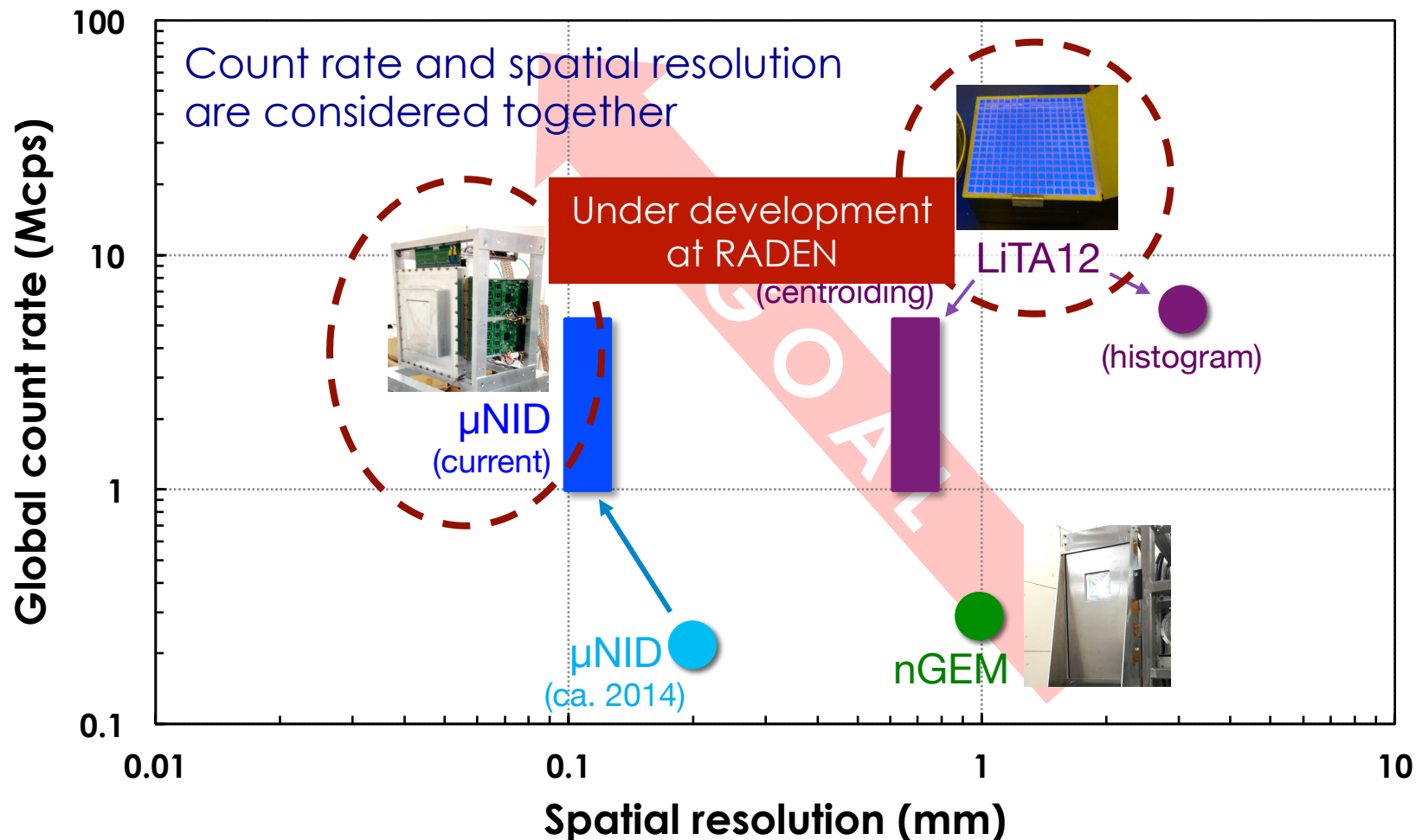


	nGEM	μNID	LiTA12
Detector type	Micropattern	Micropattern	Scintillator
Converter material	^{10}B	^3He	^6Li
Active area	10 cm x 10 cm	10 cm x 10 cm	5 cm x 5 cm
Spatial resolution	1 mm	0.1 mm	3 mm/0.7 mm
Time resolution	10 ns	250 ns	40 ns
Efficiency (thermal)	10%	26%	23%
Global peak count rate	0.2 Mcps	>1 Mcps	6 Mcps
Gamma sensitivity	10^{-4}	$< 10^{-12}$	low

Current performance of event-type detectors at RADEN



Current performance of event-type detectors at RADEN



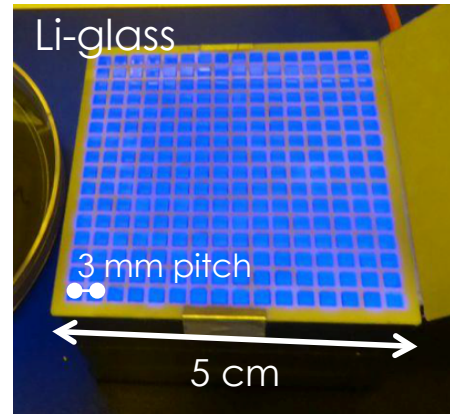
Development of counting-type detectors at RADEN

- Development of Li-glass detector
 - Improve spatial resolution using super resolution techniques
- Improvement of standard μ NID
 - Optimization of analysis code, improved ease-of-use
 - Integration into RADEN control system
- New μ NID development
 - Small-pitch MEMS μ PIC for improved spatial resolution
 - μ NID with boron converter for increased rate

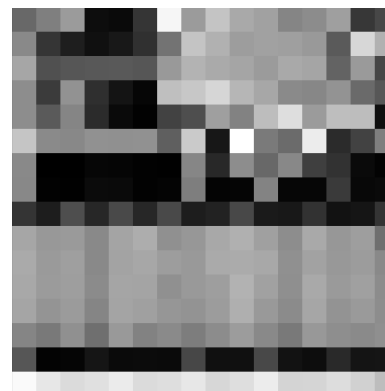
LiTA12 with super resolution methods

- Centroiding with single scintillator (T.Kai et al., Physica B, 2018)
 - Pixels replaced with 1 mm thick plate, event mode
 - Spatial resolution improved to ~ 0.7 mm
- Image stepping
 - Pixels, histogram mode
 - Composite multiple images taken at sub-pixel shifts
 - Spatial resolution may be improved $\rightarrow$ Develop reconstruction procedure

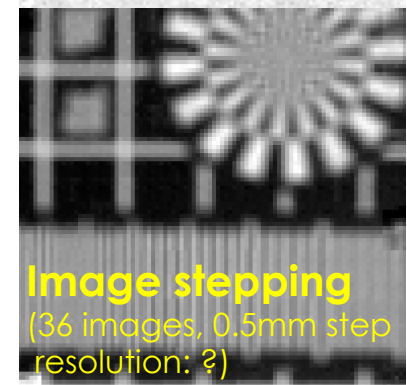
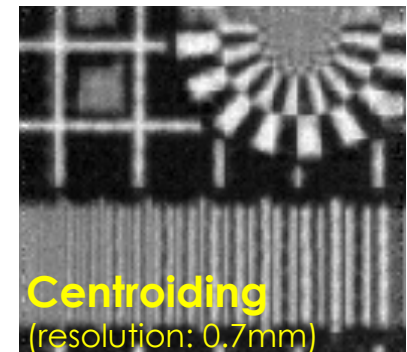
- New FPGA boards for event readout mode
- Data analysis software, integrated control software now in preparation



Area	5 cm x 5 cm
Spatial res.	3 mm
Time res.	40 ns ~
Eff. (thermal)	23%
Count rate	6 Mcps



Gd test chart
(pixel, histogram mode, resolution: 3mm)



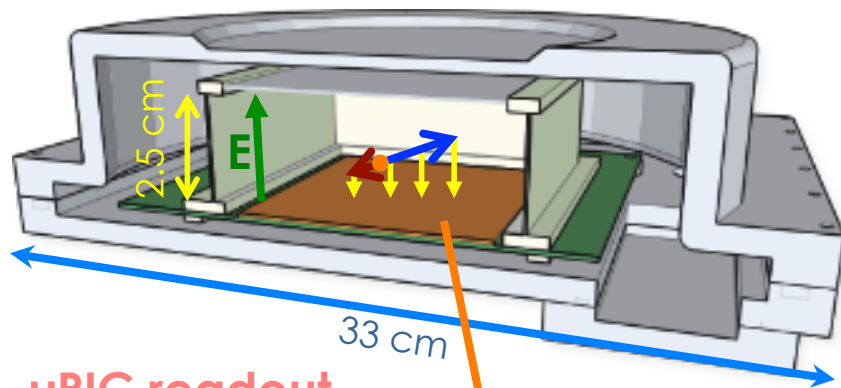
Development of counting-type detectors at RADEN

- Development of Li-glass detector
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μ PIC-based neutron imaging detector (μ NID)

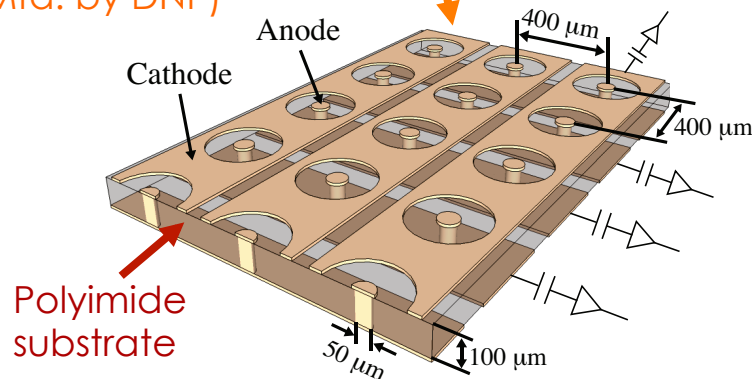
Neutron detection via $n + {}^3\text{He} \rightarrow p + t$

Overall track length ~ 4 mm in gas



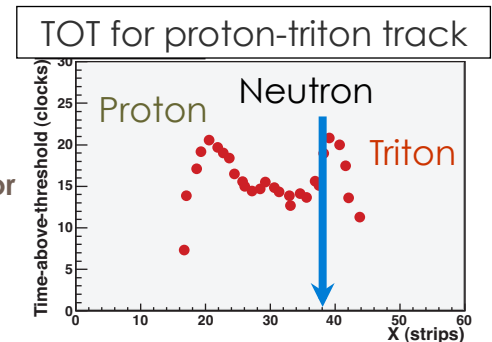
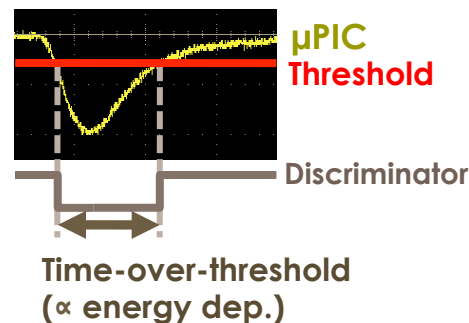
μ PIC readout

10 cm x 10 cm area,
400 μm pitch x,y strips
(Mfd. by DNP)



- Gaseous time-projection-chamber
 - $\text{CF}_4\text{-iC}_4\text{H}_{10}\text{-}^3\text{He}$ (45:5:50) at 2 atm
 - μ PIC micropattern readout
 - Compact ASIC+FPGA data encoder front-end
- 3-dimensional tracking of decay pattern + time-over-threshold
 - Accurate position reconstruction
 - Strong gamma rejection

Digital encoder with time-over-threshold (TOT)



μ NID performance and usage at RADEN

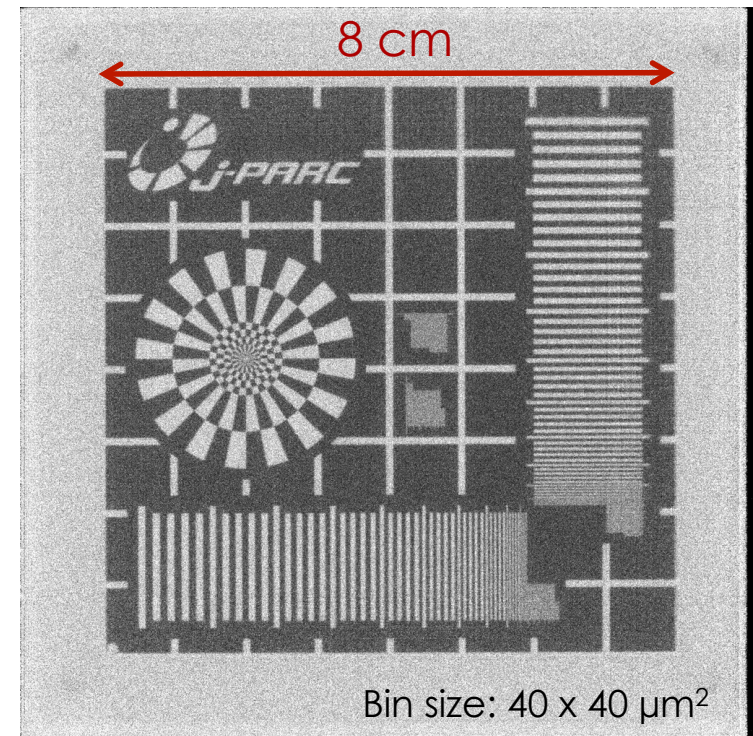
Base performance characteristics

Active area	10 x 10 cm ²
Spatial resolution	0.1 mm
Time resolution	0.25 μ s
γ -sensitivity	$< 10^{-12}$
Efficiency @25.3meV	26%
Count rate capacity	8 Mcps
Effective max count rate	> 1 Mcps

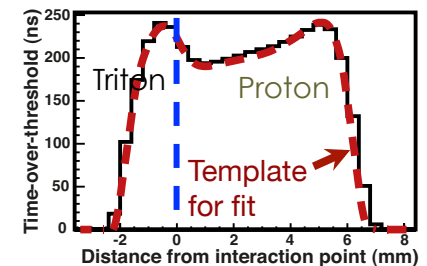
At RADEN, μ NID used primarily for:

- Magnetic imaging with polarized neutrons
- Phase-contrast imaging
- Bragg-edge transmission imaging

Image of Gd test target

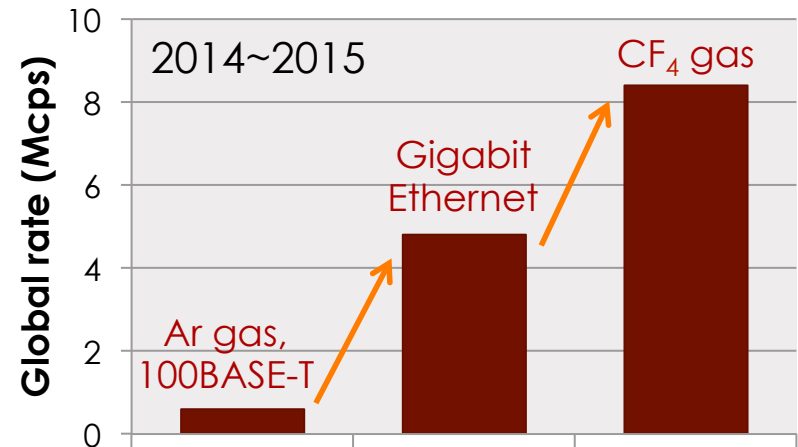


Fine spatial resolution using template fit to TOT distribution

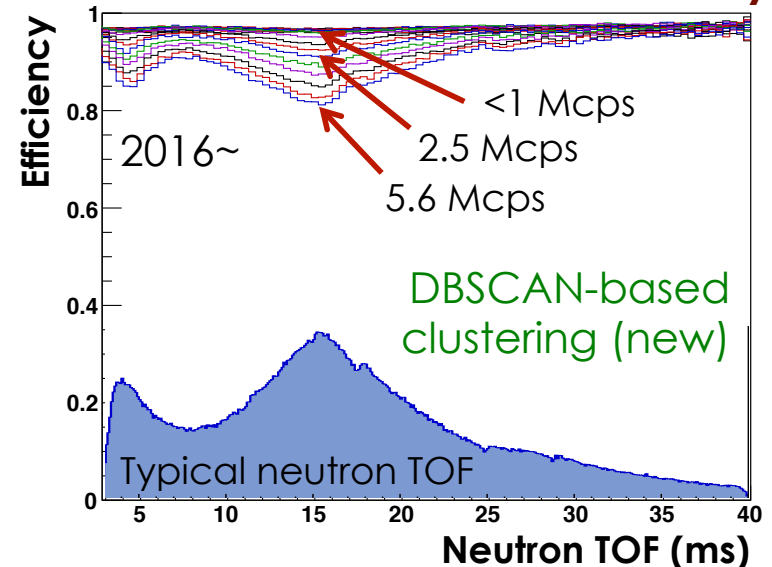


Initial development at RADEN

- Upgraded data encoder hardware and optimized gas mixture for increased rate
 - Increased peak rate from 0.6 Mcps to 8 Mcps
- Usable rate limited by event pile-up in offline analysis
 - Optimized clustering algorithm for rate > 1 Mcps
- Additional improvements with optimized gas mixture
 - Improved spatial resolution from 0.2 to 0.1 mm
 - Increased thermal neutron efficiency from 18% to 26%



Event reconstruction efficiency



μ NID control software/analysis GUI

- New DAQ controller hardware and detector control software
 - Based on DAQ middleware
 - Full integration into beam line control system
 - In use since March 2018
- New browser-based UI for offline analysis
 - In use since April 2018
 - First update with simplified interface, better data visualization, etc., in October 2018

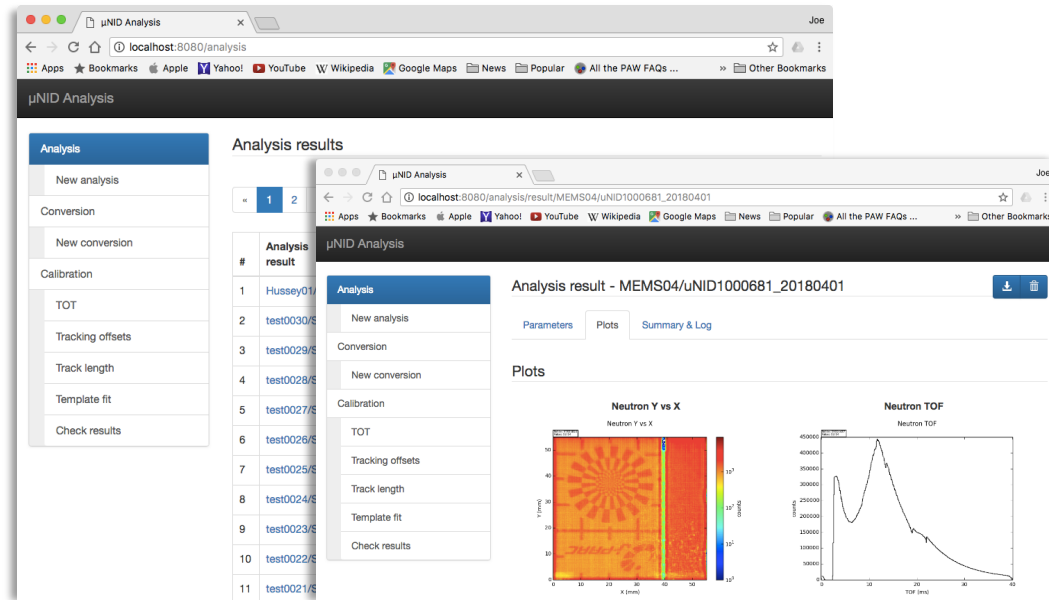
*DAQ controller and software by BBT

Software frameworks at the MLF

IROHA2 – Experimental device control system with web-based UI (MLF)

DAQ Middleware – Detector control and data collection (KEK)

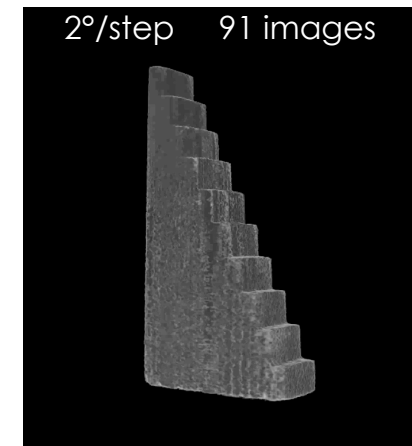
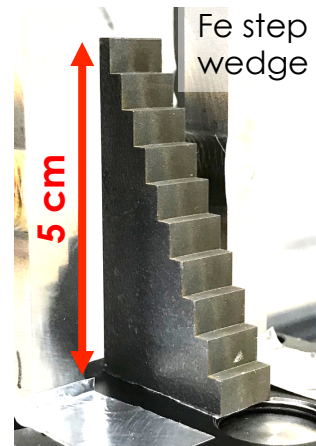
μ NID analysis GUI



Automated measurements

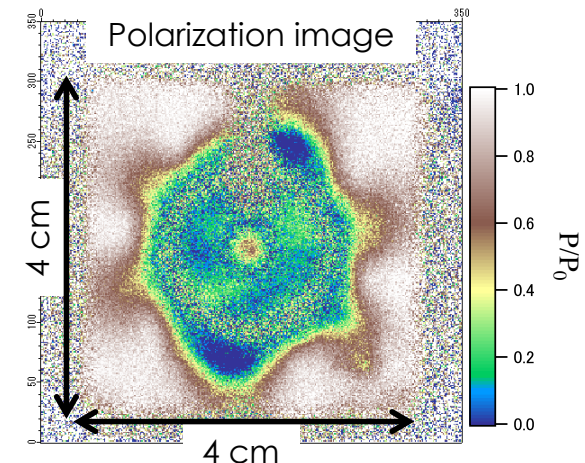
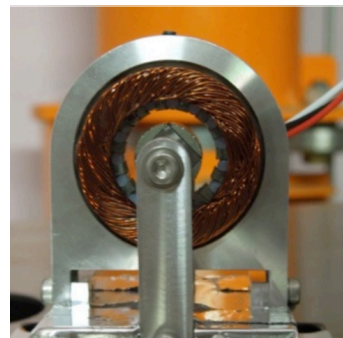
- Increased rate and integrated control
 - Perform complex measurements more easily
- Computed tomography with TOF
 - Quantify effects of scattering, beam hardening, etc.
 - Combine with energy-resolved imaging techniques
- Dynamic samples
 - Fold TOF info with motion/process frequency
 - Currently limited to cyclical processes

Computed tomography



Magnetic imaging of running motor

Model electric motor (provided by Hitachi)



Continuing development with standard μ NID

- Continue refinement of clustering, position reconstruction
- Update FPGA firmware for data encoders
 - Incorporate buffering for increased rate capacity above 10 Mcps
- Investigate new gas mixtures for increased efficiency, optimized event size
- Combine energy-resolved and conventional CT
 - Use feedback from energy-resolved CT to improve quantitativity of conventional CT
 - Combine resonance CT with conventional CT for improved visualization of isotopic density/temperature
 - Use Bragg-edge information from energy-resolved CT to guide conventional CT

Development of counting-type detectors at RADEN

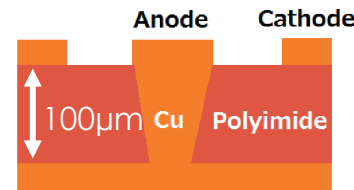
- Development of Li-glass detector
 - Improve spatial resolution using super resolution techniques
- Improvement of standard μ NID
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- New μ NID development
 - Small-pitch MEMS μ PIC for improved spatial resolution
 - μ NID with boron converter for increased rate

Small pitch for improved spatial resolution

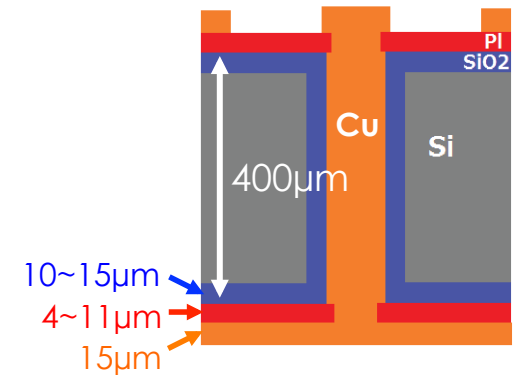
- Develop small-pitch μ PIC with MEMS manufacturing
 - Produced 215 μ m pitch μ PIC (down from 400 μ m)
 - Mfd. by DNP
- Tested at RADEN
 - Confirmed sufficient gain
 - Spatial resolution not improved as expected
 - Gain instability under neutron exposure

- **Spatial resolution:** optimize gas for shorter track length
- **Gain stability:** new MEMS μ PIC with glass substrate prepared

Current PCB μ PIC
(400 μ m pitch)

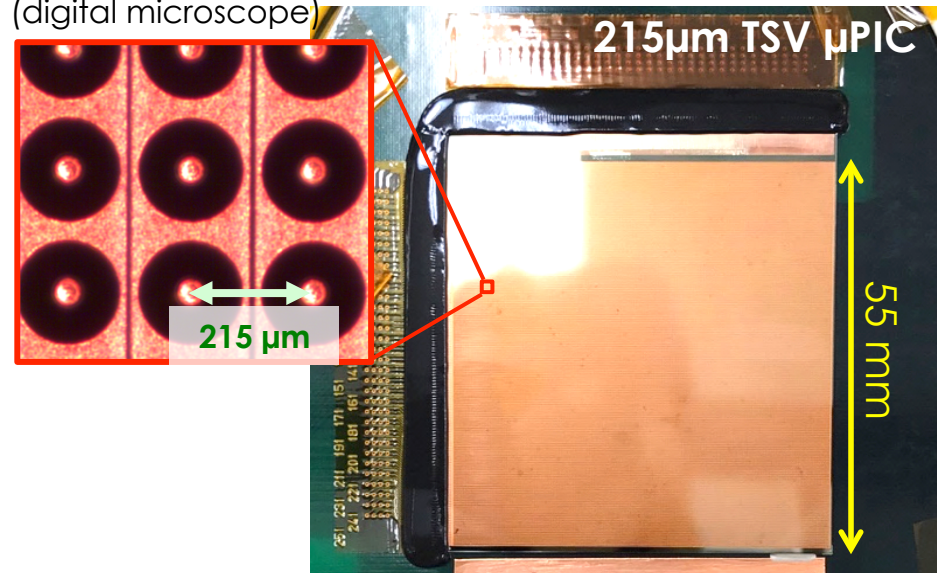


TSV* μ PIC



* TSV = Thru-silicon-via

Surface of TSV μ PIC
(digital microscope)



MEMS μ PIC with glass substrate (12/10)

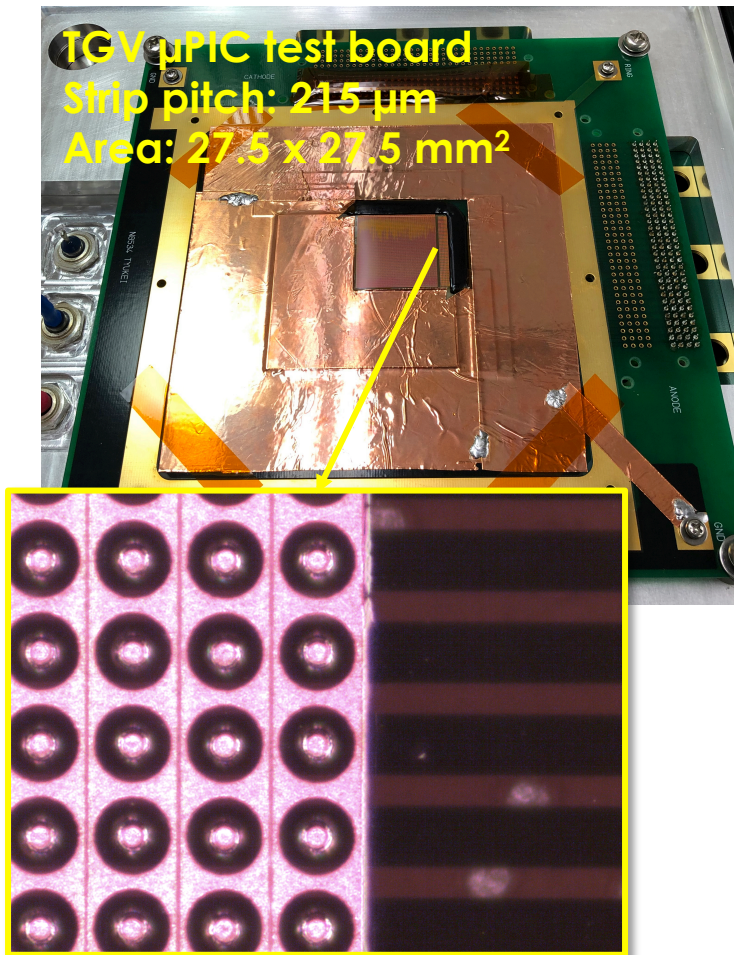
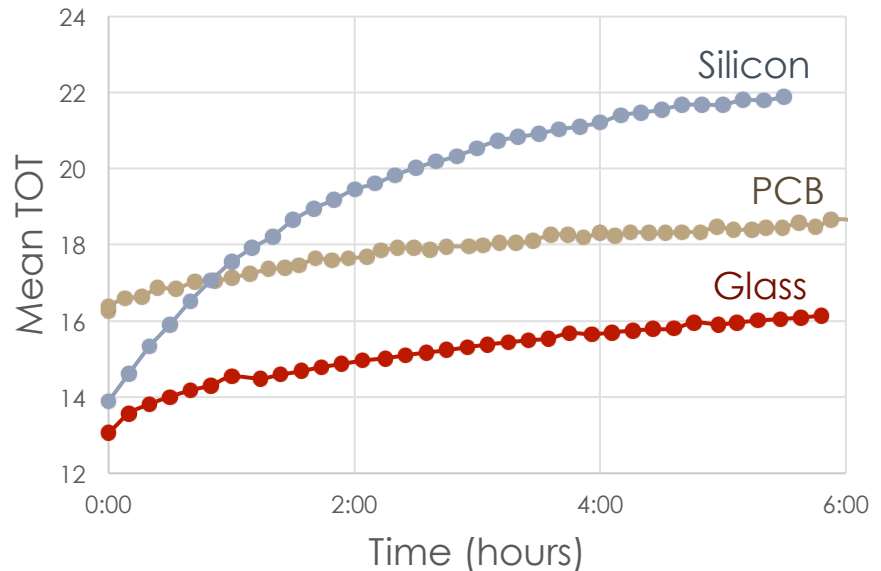


Image from digital microscope

TGV μ PIC – Thru-glass-via μ PIC

μ PIC gain stability at RADEN



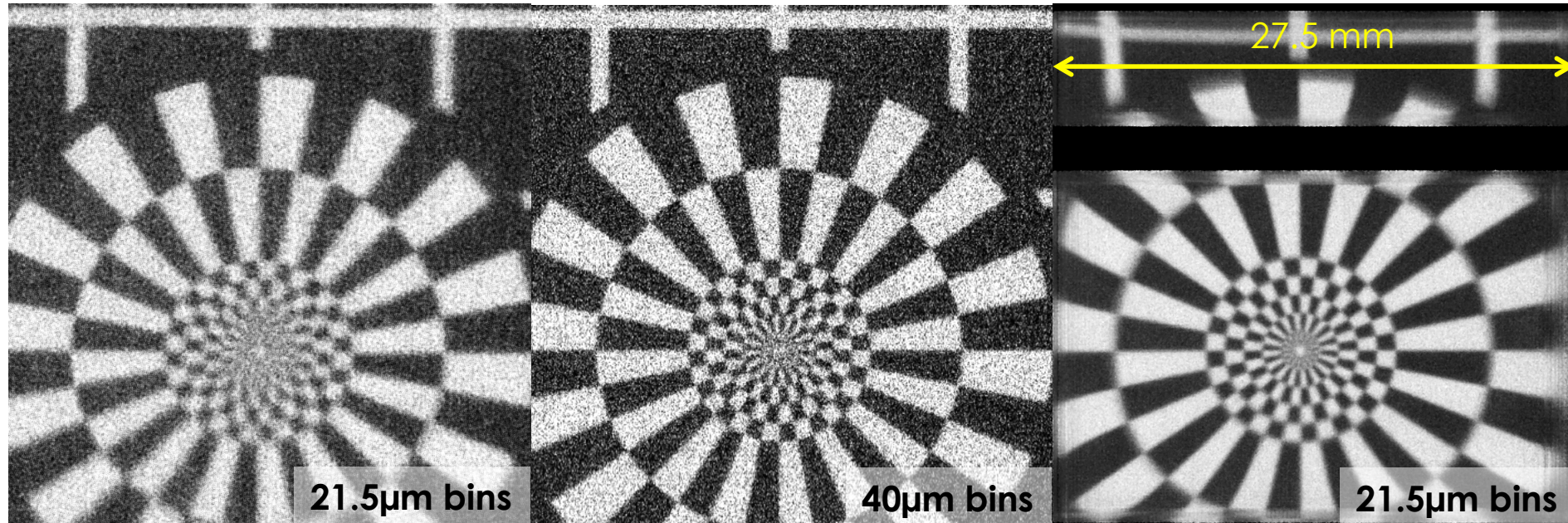
- Initial testing performed at Kyoto U.
- Gain stability measured at RADEN
 - Improved over silicon substrate
 - Similar or slightly worse than PCB μ PIC

Imaging with the 215 μm MEMS μPIC s

215 μm pitch
Silicon substrate

400 μm pitch
PCB μPIC

215 μm pitch
Glass substrate

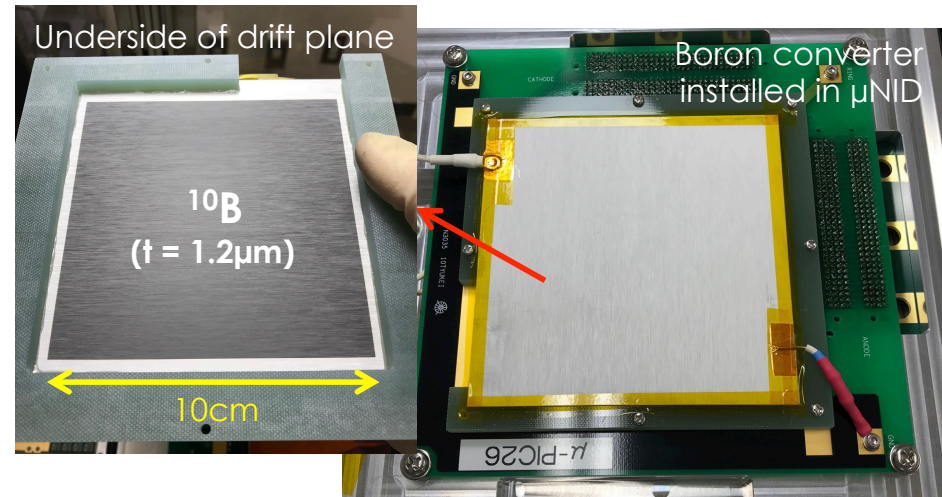


- Image quality with TGV μPIC looks good
- Resolution may be improved compared to PCB μPIC

Note: measurement statistics are different for each image

Boron converter for increased rate

- 3x smaller event size compared to ^3He
 - Trade-off in spatial resolution
- μNID with flat boron converter for initial testing
 - Thin, $1.2\mu\text{m}$ ^{10}B layer $\rightarrow$ low efficiency (3~5%)

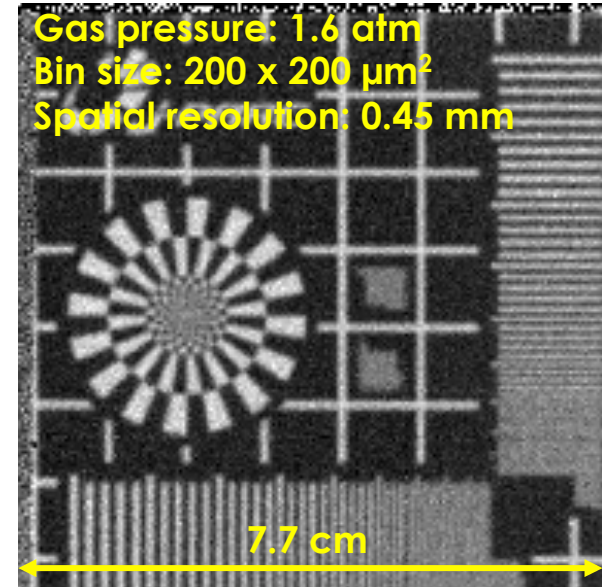


Initial testing at RADEN

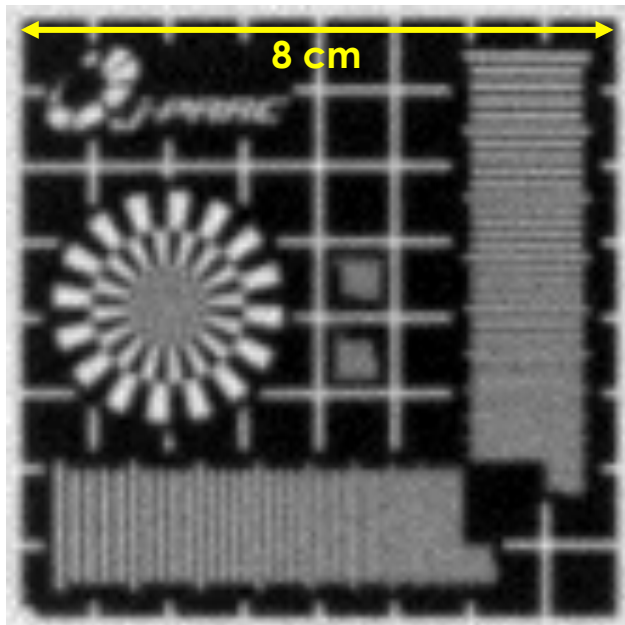
- Maximum count rate of 22 Mcps
- Spatial resolution of 0.45 mm

Next:

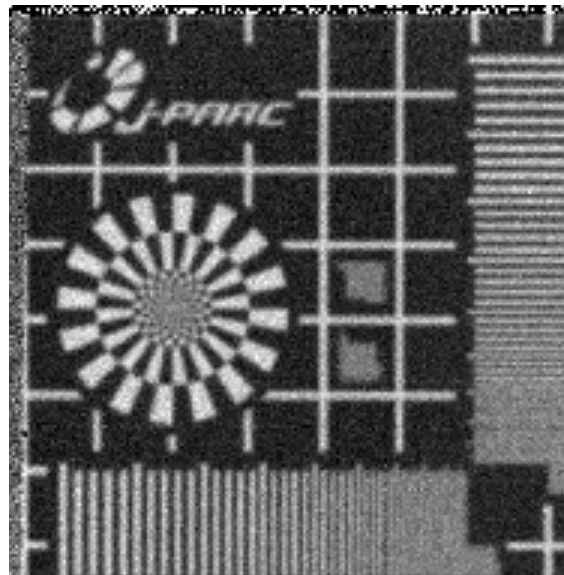
- Prepare dedicated Boron- μNID system
- Optimize gas for shorter track lengths
- Design new converter for increased efficiency



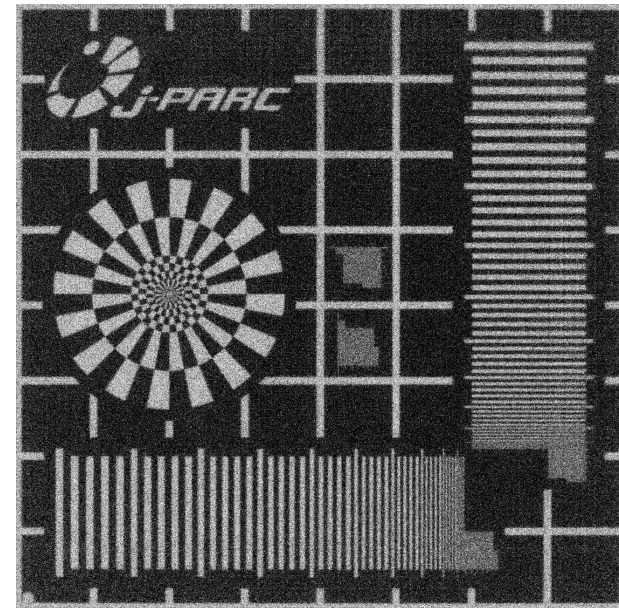
Comparison of imaging for nGEM, B- μ NID, and μ NID



nGEM
Spatial resolution: 1 mm

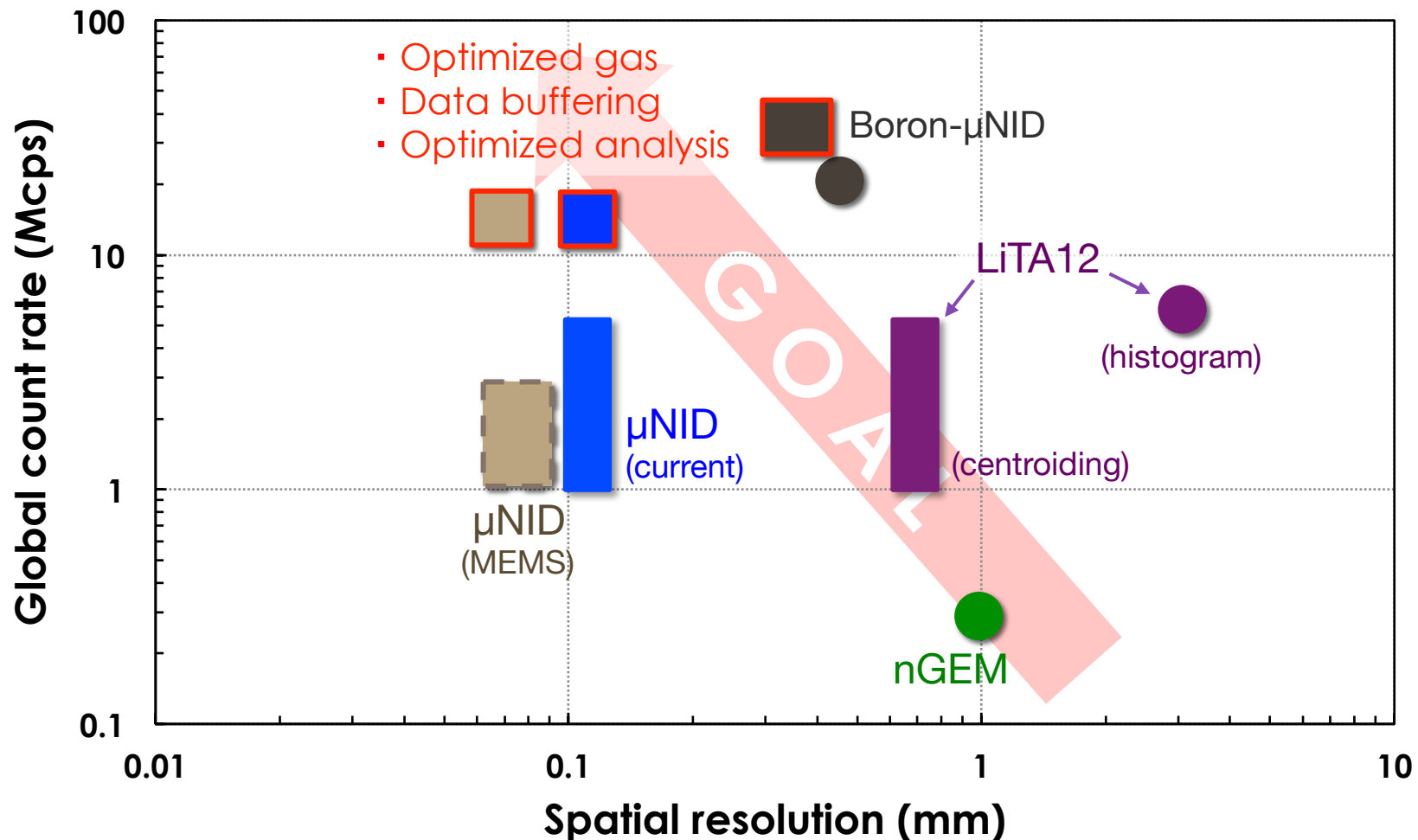


B- μ NID (1.6 atm)
0.45 mm



Standard μ NID (^3He)
0.1 mm

Current and projected performance of event-type detectors at RADEN



Summary

- Development of detectors to meet the needs of energy-resolved neutron imaging at RADEN is ongoing
- LiTA12
 - Improved spatial resolution using super resolution techniques
 - Now preparing analysis/control software
- Standard μ NID
 - Improved rate performance to over 1 Mcps
 - Fully integrated detector into RADEN control system
 - Begin study of energy-resolved CT with the μ NID
- New μ NID development
 - Promising test of small-pitch μ PIC on glass substrate → prepare larger-area test element
 - Confirmed operation of μ NID with boron converter → prepare dedicated Boron- μ NID detector system

RADEN and μ NID development members

CROSS

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KEK

(LiTA12 development)

Setsuo Satoh